EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L10	68950	(cushion$6 or flexible or (stress near5 absorb) or protect$6 or passivat$6 or encapsula$6) same (spray$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:11
L11	19820	10 and (semiconductor or packag$6 or IC or (integrated adj circuit) or chip or die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:11
L12	18273	11 and (@ad<"20031030" or @rlad<"20031030")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:11
L13	8885	12 and (groove or trench or opening or scrib$6 or singula$6 or recess$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:11
L14	4657	13 and ((bond$6 or attach$6 or adhe$6 or solder$6) same (substrate or wafer or support$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:13
L15	1563	14 and ((cushion$6 or flexible or (stress near5 absorb) or protect$6 or passivat$6) with spray$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/07 16:13